

DATASHEET

1.9mm Round Subminiature Axial Infrared LED SIR95-21C/TR10



Features

- Small double-end package
- High reliability
- Low forward voltage
- Good spectral matching to Si photodetector
- Pb free
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Descriptions

• SIR95-21C/TR10 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens. The device is spectrally matched with silicon photodiode and phototransistor.

Applications

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

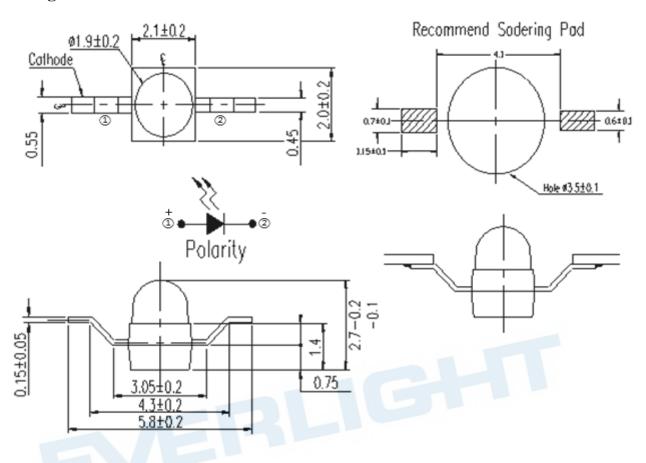
Device Selection Guide

Part Category	Chip Material	Resin Color
SIR	GaAlAs	Water Clear

1



Package Dimensions



Notes: 1.All dimensions are in millimeters

2.Tolerances unless dimensions ±0.1mm



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units	
Continuous Forward Current	I_{F}	65	mA	
Reverse Voltage	V_R	5	V	
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	T_{stg}	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	T_{sol}	260	$^{\circ}\!\mathbb{C}$	
Power Dissipation at (or below) 25°C Free Air Temperature	P _d	110	mW	

Notes: *1:Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units	
Radiant Intensity	I_{e}	$I_F=20mA$	2.0	4.0		mW/sr	
		$I_F=100 mA$ Pulse width \leq 100us.Duty \leq 1%		20			
Peak Wavelength	λр	I _F =20mA		875		nm	
Spectral Bandwidth	Δλ	I _F =20mA		80		nm	
Forward Voltage	V_{F}	I _F =20mA		1.3	1.6	V	
		$I_F=100 mA$ Pulse width $\leq 100 us.Duty \leq 1\%$		1.4	1.8		
Reverse Current	I_R	$V_R=5V$			10	μ A	
View Angle	2 \theta 1/2	$I_F=20mA$		25		deg	



Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs.

Ambient Temperature

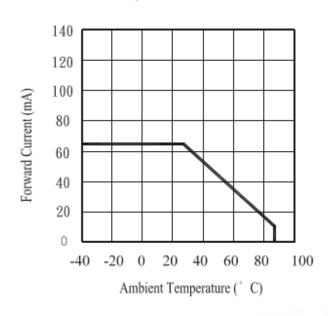


Fig.2 Spectral Distribution

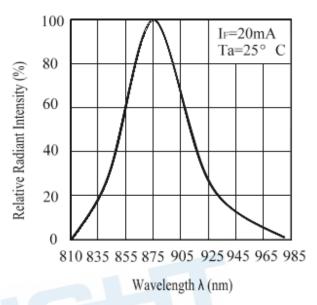


Fig.3 Peak Emission Wavelength
Ambient Temperature

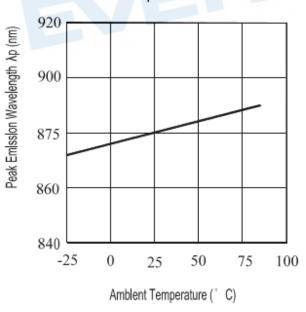
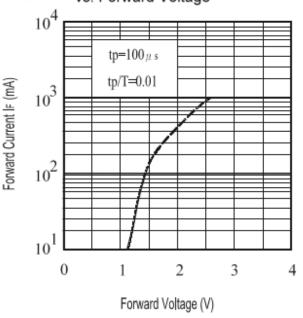


Fig.4 Forward Current vs. Forward Voltage





Typical Electro-Optical Characteristics Curves

Fig.5 Relative Intensity vs.
Forward Current

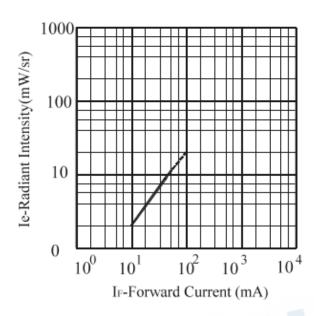
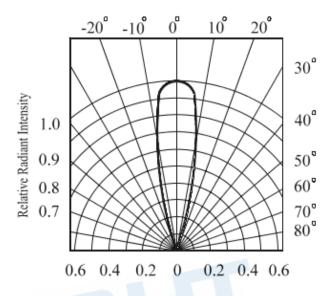


Fig.6 Relative Radiant Intensity vs.

Angular Displacement





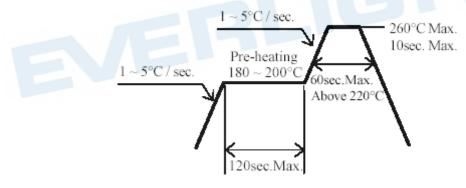
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 168 hours (7 days) under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 48 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



Note:

- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

1.9mm Round Subminiature Axial Infrared LED SIR95-21C/TR10

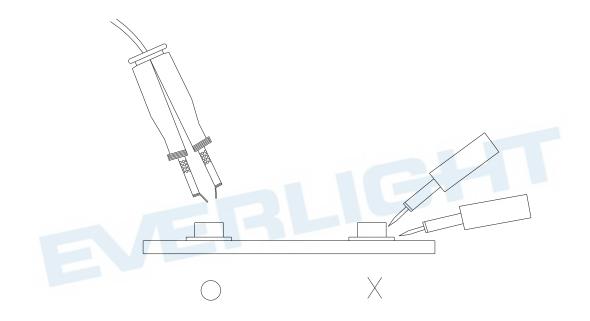


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

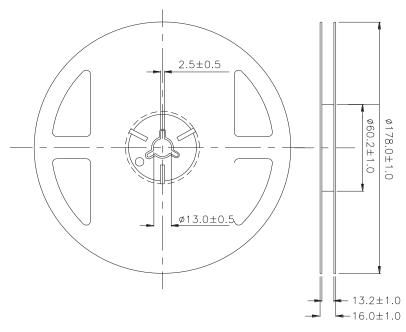
5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

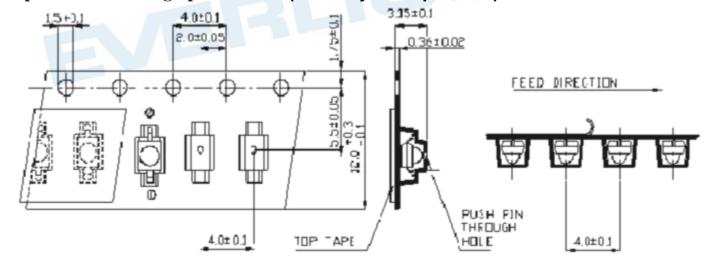




Package Dimensions



Tape & Reel Packing Specifications(Quantity: 1000pcs/reel)

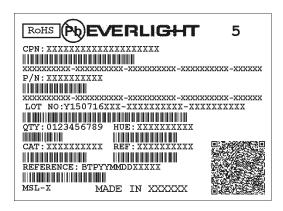




Note: The tolerances unless mentioned are ±0.1mm, Unit: mm.



Label Form Specification



CPN: Customer's Production Number

P/N: Production Number **OTY:** Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

DISCLAIMER

- EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- The product meets EVERLIGHT published specification for a period of twelve (12) months 2. from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- When using this product, please observe the absolute maximum ratings and the instructions for 4. using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 5. These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without obtaining EVERLIGHT's prior consent.
- This product is not intended to be used for military, aircraft, automotive, medical, life 6. sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.